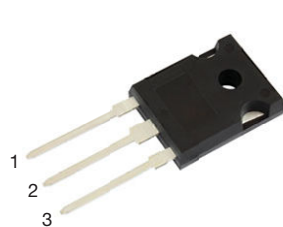
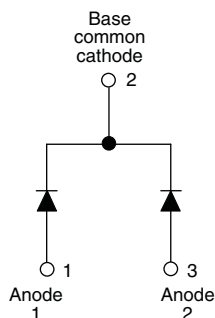


## Hyperfast Soft Recovery Diode, 2 x 30 A FRED Pt® Gen 4



TO-247AD 3L



### FEATURES

- Gen 4 FRED Pt® technology
- Low  $I_{RRM}$  and reverse recovery charge
- Very low forward voltage drop
- Polyimide passivated chip for high reliability standard
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2 x 30 A
$V_R$	600 V
$V_F$ at $I_F$	1.37 V
$t_{rr}$ typ.	see Recovery table
$T_J$ max.	175 °C
Package	TO-247AD 3L
Circuit configuration	Common cathode

### DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	$V_R$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 122\text{ °C}$	30	A
Non-repetitive peak surge current, per leg	$I_{FSM}$	$T_C = 25\text{ °C}$ , $t_p = 8.3\text{ ms}$ , half sine wave	240	
Operating junction and storage temperatures	$T_J$ , $T_{Stg}$		-55 to +175	°C

### ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}$ , $V_R$	$I_R = 100\text{ }\mu\text{A}$	600	-	-	V
Forward voltage	$V_F$	$I_F = 30\text{ A}$	-	1.65	2	
		$I_F = 60\text{ A}$	-	1.95	-	
		$I_F = 30\text{ A}$ , $T_J = 125\text{ °C}$	-	1.44	-	
		$I_F = 60\text{ A}$ , $T_J = 125\text{ °C}$	-	1.78	-	
		$I_F = 30\text{ A}$ , $T_J = 150\text{ °C}$	-	1.37	1.6	
		$I_F = 60\text{ A}$ , $T_J = 150\text{ °C}$	-	1.68	-	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	-	50	$\mu\text{A}$
		$T_J = 125\text{ °C}$ , $V_R = V_R$ rated	-	-	500	
Junction capacitance	$C_T$	$V_R = 600\text{ V}$	-	18.3	-	pF

**DYNAMIC RECOVERY CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	55	-	ns
		$T_J = 125\text{ }^{\circ}\text{C}$	-	75	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	13	-	A
		$T_J = 125\text{ }^{\circ}\text{C}$	-	23	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	500	-	nC
		$T_J = 125\text{ }^{\circ}\text{C}$	-	1250	-	

**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction to case	$R_{thJC}$		-	-	1	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{thJA}$	Typical socket mount	-	-	40	
Thermal resistance, case to heat sink	$R_{thCS}$	Mounting surface, flat, smooth, and greased	-	0.4	-	
Weight			-	6.0	-	g
			-	0.21	-	oz.
Mounting torque			6.0 (5)	-	12 (20)	kgf · cm (lbf · in)
Marking device		Case style TO-247AD 3L	C4PH6006L			

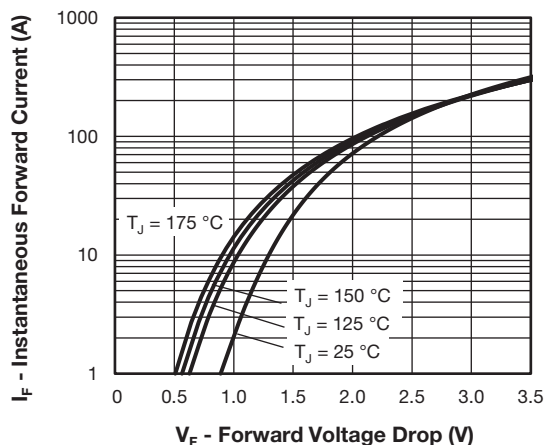


Fig. 1 - Typical Forward Voltage Drop Characteristics

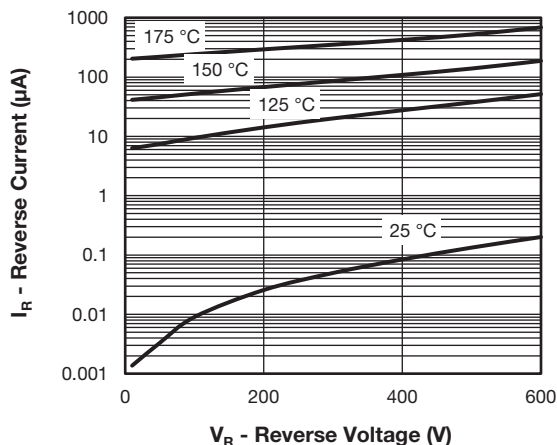


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

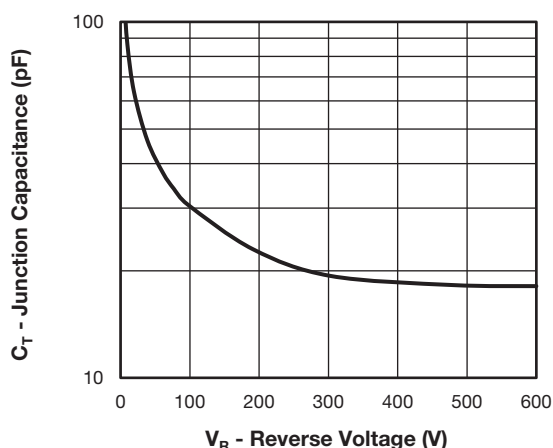


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

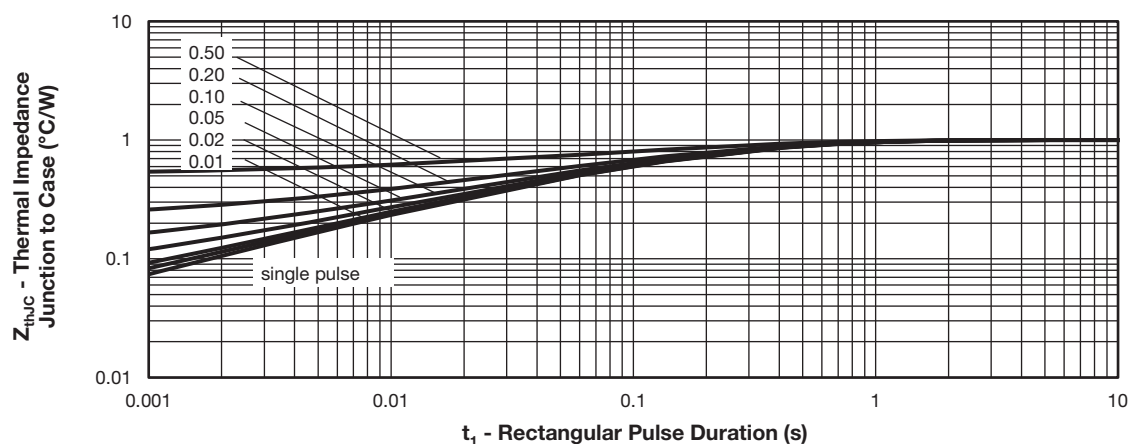
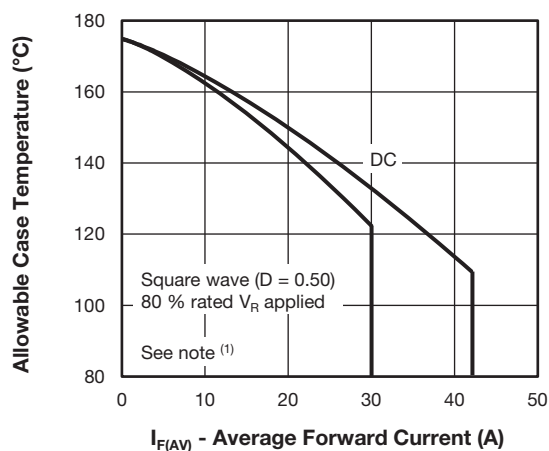

Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics


Fig. 5 - Max. Allowable Case Temperature vs. Average Forward Current

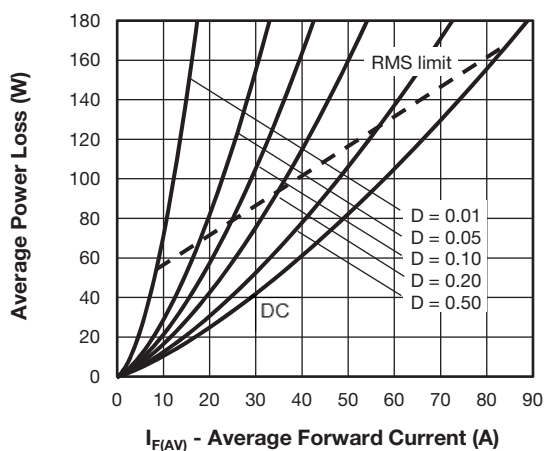
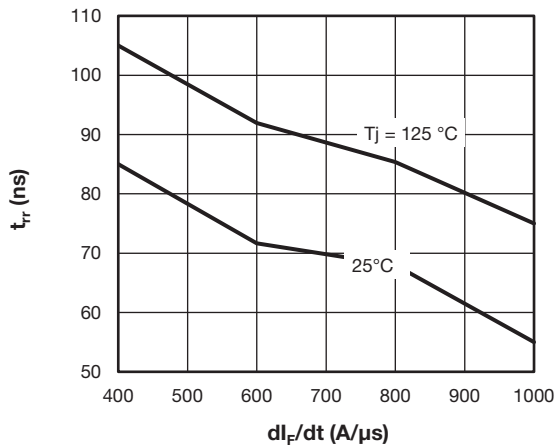
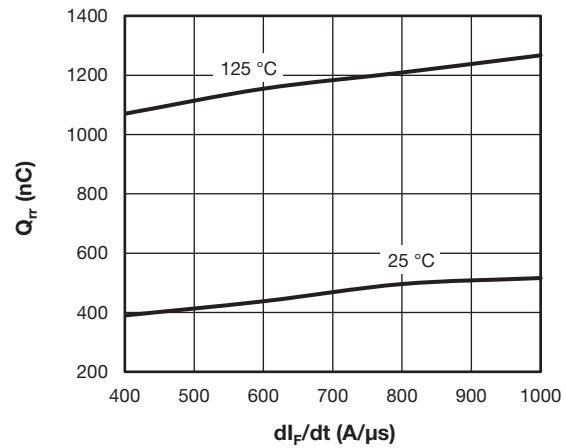
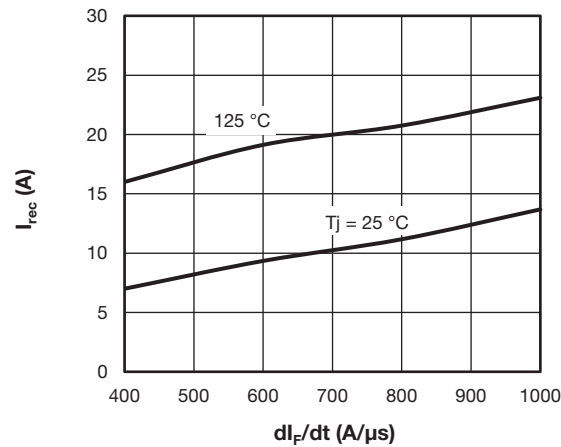


Fig. 6 - Forward Power Loss Characteristics

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see Fig.5)  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_R$  = rated  $V_R$


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$ 

Fig. 9 - Typical Reverse Recovery vs.  $dI_F/dt$

**ORDERING INFORMATION TABLE**

Device code	<b>VS-</b>	<b>C</b>	<b>4</b>	<b>P</b>	<b>H</b>	<b>60</b>	<b>06</b>	<b>L</b>	<b>-N3</b>
	1	2	3	4	5	6	7	8	9
<b>1</b>	- Vishay Semiconductors product								
<b>2</b>	- Circuit configuration: C = common cathode								
<b>3</b>	- FRED Gen 4								
<b>4</b>	- P = TO-247 package								
<b>5</b>	- Process type: H = hyperfast recovery								
<b>6</b>	- Current rating (60 = 60 A)								
<b>7</b>	- Voltage rating (06 = 600 V)								
<b>8</b>	- L = long lead								
<b>9</b>	- Environmental digit: -N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free								

**ORDERING INFORMATION** (Example)

PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-C4PH6006L-N3	25	500	Antistatic plastic tube

**LINKS TO RELATED DOCUMENTS**

Dimensions	<a href="http://www.vishay.com/doc?95626">www.vishay.com/doc?95626</a>
Part marking information	<a href="http://www.vishay.com/doc?95007">www.vishay.com/doc?95007</a>

### TO-247AD 3L

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
c	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
e	5.46 BSC		0.215 BSC		
$\phi K$	0.254		0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
$\phi P$	3.56	3.66	0.14	0.144	
$\phi P1$	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		

#### Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Contour of slot optional
- Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions D1 and E1
- Lead finish uncontrolled in L1
- $\phi P$  to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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